MITSUBISHI ELECTRIC

< Silicon RF Power MOS FET (Discrete) >

RD16HHF1

RoHS Compliance, Silicon MOSFET Power Transistor 30MHz,16W

DESCRIPTION

RD16HHF1 is a MOS FET type transistor specifically designed for HF RF power amplifiers applications.

FEATURES

High power gain:

Pout>16W, Gp>16dB @Vdd=12.5V,f=30MHz

APPLICATION

For output stage of high power amplifiers in HF band mobile radio sets.

RoHS COMPLIANT

RD16HHF1-101 is a RoHS compliant products.

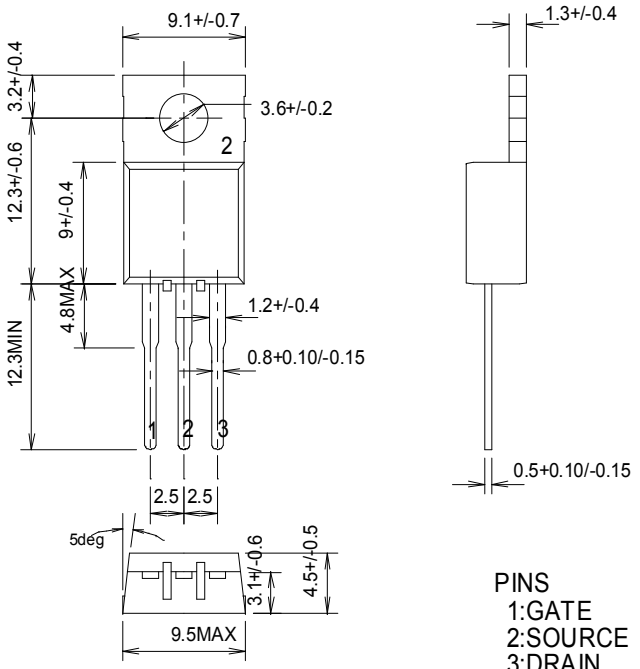
RoHS compliance is indicate by the letter “G” after the lot marking.

This product include the lead in high melting temperature type solders.

However, it is applicable to the following exceptions of RoHS Directions.

1.Lead in high melting temperature type solders(i.e.tin-lead solder alloys containing more than85% lead.)

OUTLINE DRAWING



PINS
1:GATE
2:SOURCE
3:DRAIN

note:
Torelance of no designation means typical value.
Dimension in mm.

RD16HHF1

RoHS Compliance, Silicon MOSFET Power Transistor 30MHz,16W

ABSOLUTE MAXIMUM RATINGS

(Tc=25°C UNLESS OTHERWISE NOTED)

SYMBOL	PARAMETER	CONDITIONS	RATINGS	UNIT
V_{DSS}	Drain to source voltage	Vgs=0V	50	V
V_{GSS}	Gate to source voltage	Vds=0V	+/- 20	V
Pch	Channel dissipation	Tc=25°C	56.8	W
Pin	Input power	Zg=Zl=50Ω	0.8	W
ID	Drain to source current	-	5	A
Tch	Channel temperature	-	150	°C
Tstg	Storage temperature	-	-40 to +150	°C
Rth j-c	Thermal resistance	junction to case	2.2	°C/W

Note 1: Above parameters are guaranteed independently.

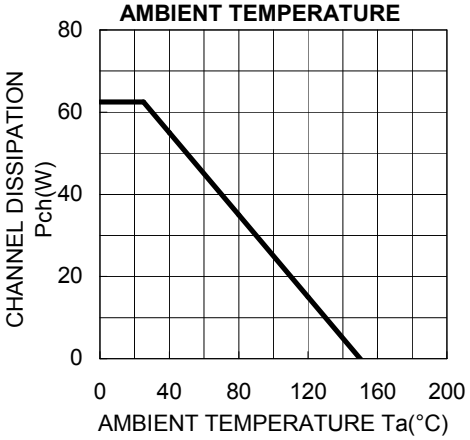
ELECTRICAL CHARACTERISTICS (Tc=25°C , UNLESS OTHERWISE NOTED)

SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX.	
I_{DSS}	Zero gate voltage drain current	V_{DS}=17V, V_{GS}=0V	-	-	10	uA
I_{GSS}	Gate to source leak current	V_{GS}=10V, V_{DS}=0V	-	-	1	uA
V_{TH}	Gate threshold voltage	V_{DS}=12V, I_{DS}=1mA	1.7	-	4.7	V
Pout	Output power	V_{DD}=12.5V, Pin=0.4W,	16	19	-	W
ηD	Drain efficiency	f=30MHz, Idq=0.5A	55	65	-	%
	Load VSWR tolerance	V_{DD}=15.2V,Po=16W(Pin Control) f=30MHz,Idq=0.5A,Zg=50Ω Load VSWR=20:1(All Phase)	No destroy			-

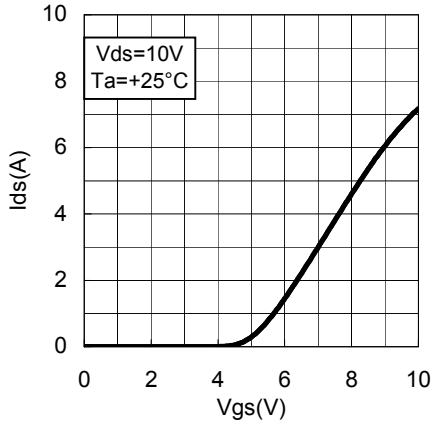
Note : Above parameters , ratings , limits and conditions are subject to change.

TYPICAL CHARACTERISTICS

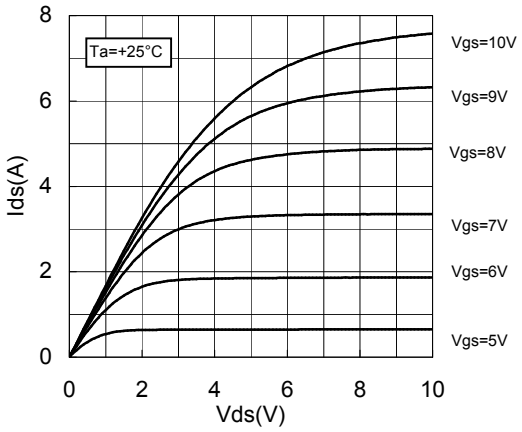
CHANNNEL DISSIPATION VS. AMBIENT TEMPERATURE



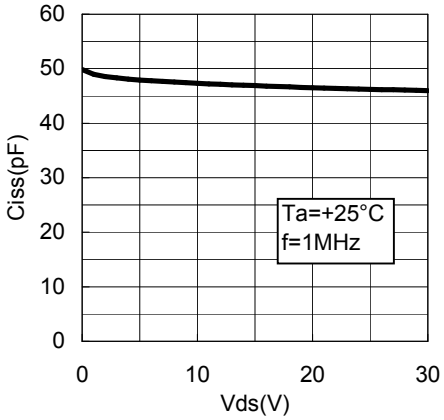
Vgs-Ids CHARACTERISTICS



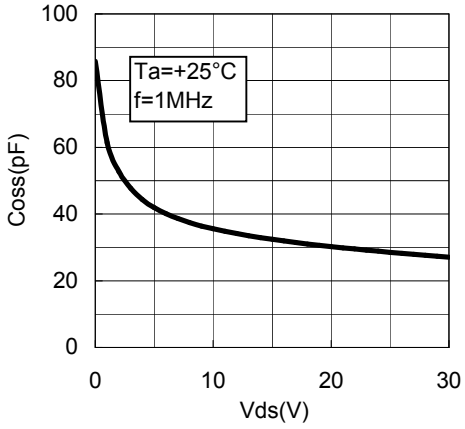
Vds-Ids CHARACTERISTICS



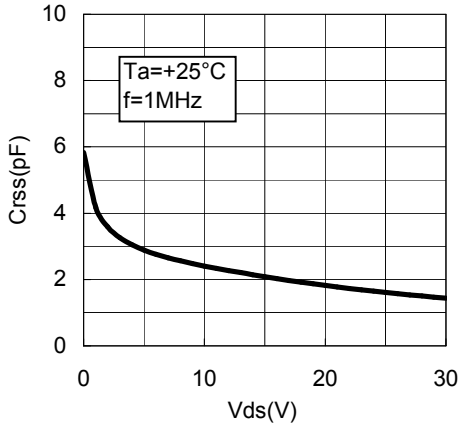
Vds VS. Ciss CHARACTERISTICS



Vds VS. Coss CHARACTERISTICS

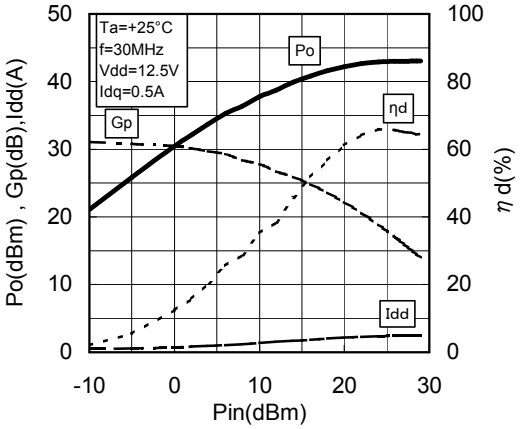


Vds VS. Crss CHARACTERISTICS

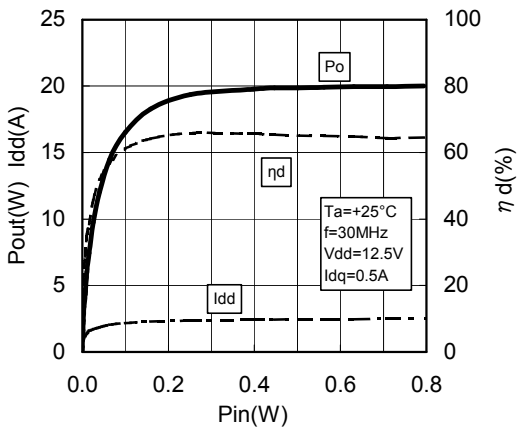


TYPICAL CHARACTERISTICS

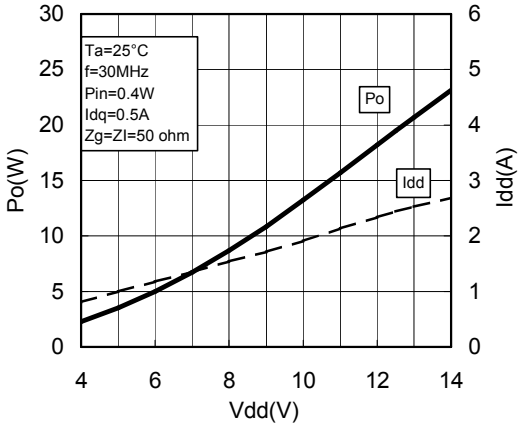
Pin-Po CHARACTERISTICS



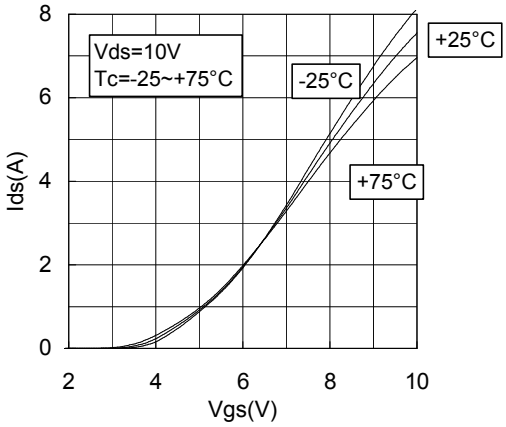
Pin-Po CHARACTERISTICS



Vdd-Po CHARACTERISTICS



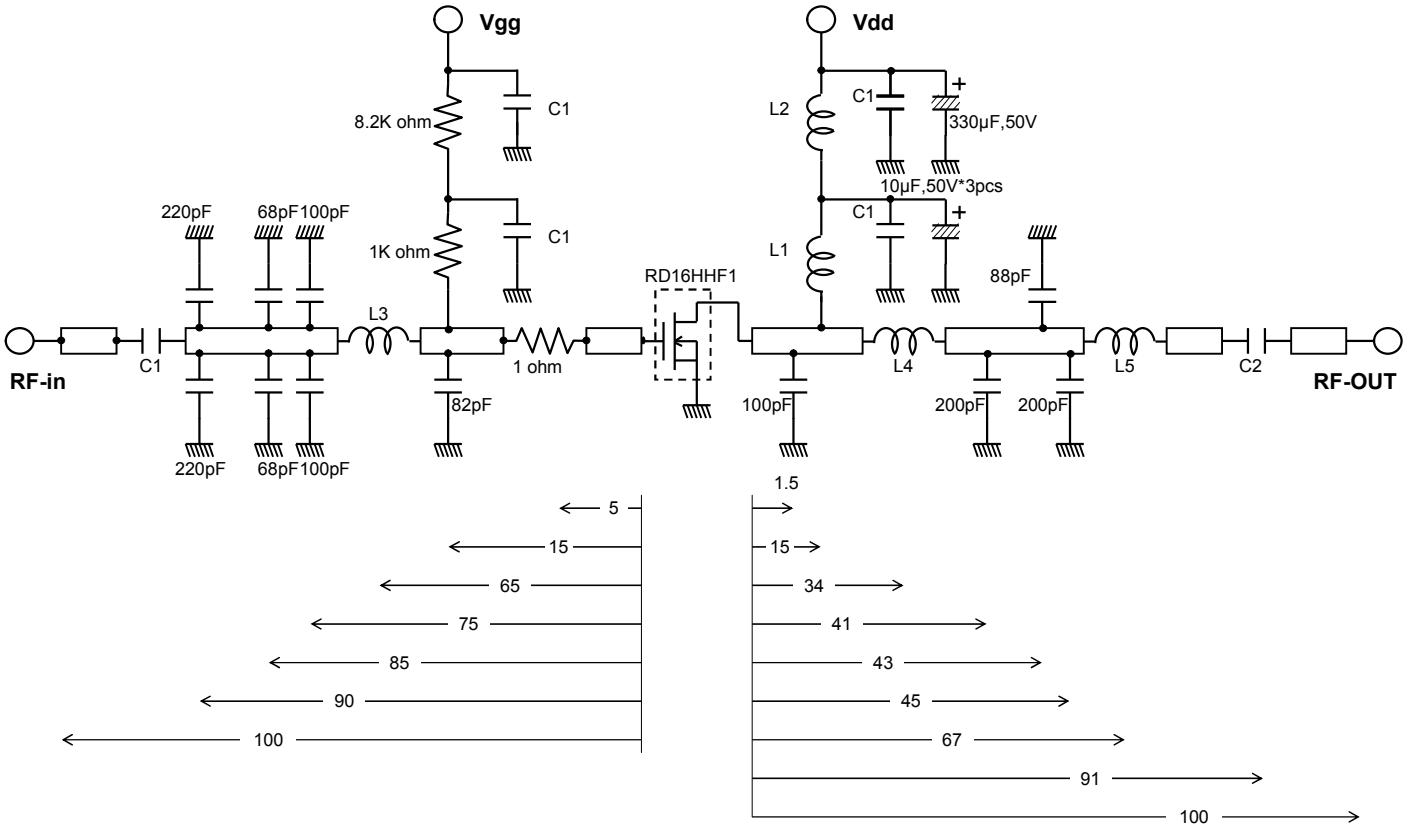
Vgs-Ids CHARACTERISTICS 2



RD16HHF1

RoHS Compliance, Silicon MOSFET Power Transistor 30MHz,16W

TEST CIRCUIT(f=30MHz)

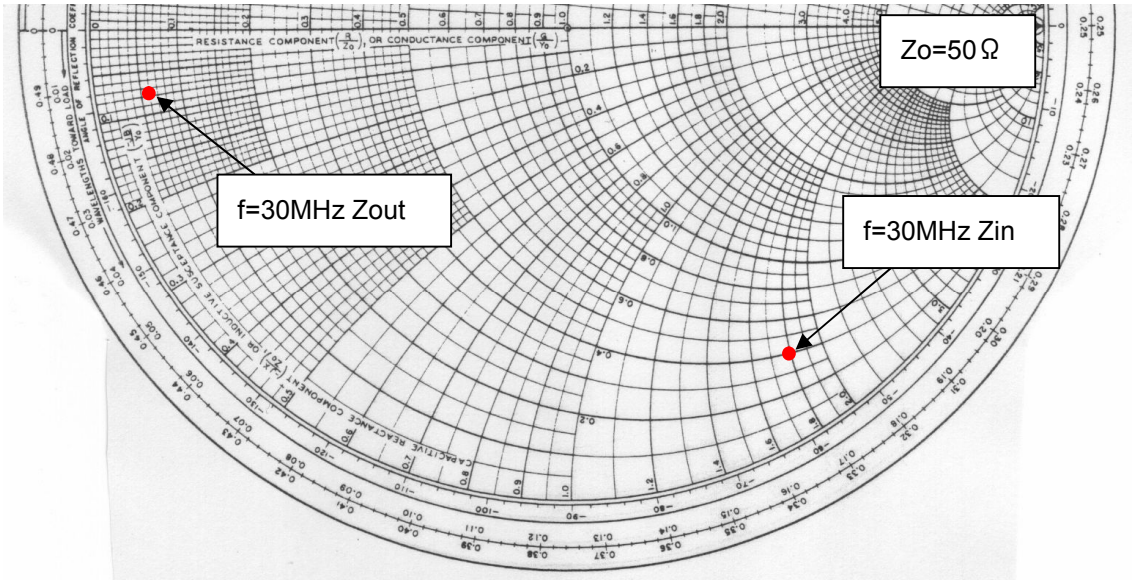


C1：100pF,0.022μF,0.1μF in parallel
C2：470pF*2 in parallel

L1: 10 Turns,I.D8mm,D0.9mm copper wire
L2: 10 Turns,I.D6mm,D1.6mm silver plateted copper wire
L3: 9 Turns,I.D5.6mm,D0.9mm copper wire
L4: 4 Turns,I.D5.6mm,D0.9mm ,P=0.5mm copper wire
L5: 5 Turns,I.D5.6mm,D0.9mm ,P=1mm copper wire

Dimensions:mm
Note:Board material PTFE substrate
Micro strip line width=4.2mm/50 ohm,er:2.7,t=1.6mm

INPUT/OUTPUT IMPEDANCE VS.FREQUENCY CHARACTERISTICS



Zin , Zout

f	Zin	Zout	
(MHz)	(ohm)	(ohm)	Conditions
30	20.02-j89.42	2.99-j3.66	Po=20W, Vdd=12.5V,Pin=0.4W

RD16HHF1 S-PARAMETER DATA (@Vdd=12.5V, Id=800mA)

Freq.	S11		S21		S12		S22	
[MHz]	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)
10	0.928	-43.2	50.035	150.2	0.013	60.6	0.705	-44.6
30	0.761	-96.8	32.680	117.1	0.025	34.3	0.588	-92.6
50	0.676	-121.9	22.018	101.3	0.027	24.3	0.540	-116.9
100	0.650	-145.8	11.543	81.0	0.025	20.3	0.543	-138.4
150	0.679	-156.4	7.560	66.2	0.023	27.0	0.586	-147.1
200	0.709	-162.7	5.380	55.7	0.022	46.4	0.633	-153.2
250	0.742	-168.0	4.126	45.9	0.026	63.2	0.698	-158.1
300	0.775	-173.0	3.208	36.9	0.034	74.4	0.727	-163.2
350	0.801	-177.7	2.592	29.6	0.045	78.3	0.769	-168.0
400	0.826	177.7	2.133	22.6	0.056	78.4	0.805	-172.8
450	0.844	173.2	1.775	16.6	0.069	78.1	0.822	-176.8
500	0.861	169.0	1.509	11.3	0.081	75.3	0.851	178.9
550	0.874	164.8	1.283	5.9	0.093	73.1	0.867	174.7
600	0.884	160.7	1.114	2.1	0.104	69.8	0.877	170.9
650	0.892	156.9	0.974	-1.9	0.117	67.2	0.894	166.9
700	0.900	153.0	0.855	-5.3	0.129	63.7	0.897	163.4
750	0.903	149.1	0.759	-8.4	0.140	60.6	0.904	159.6
800	0.908	145.5	0.678	-11.3	0.150	56.8	0.914	155.9
850	0.912	141.7	0.614	-13.5	0.161	53.8	0.915	152.9
900	0.912	137.9	0.559	-15.3	0.172	50.4	0.917	149.0
950	0.913	134.3	0.509	-17.3	0.180	47.1	0.922	145.4
1000	0.913	130.7	0.467	-17.9	0.190	43.6	0.920	142.4

ATTENTION:

1.High Temperature ; This product might have a heat generation while operation,Please take notice that have a possibility to receive a burn to touch the operating product directly or touch the product until cold after switch off. At the near the product,do not place the combustible material that have possibilities to arise the fire.

2.Generation of High Frequency Power ; This product generate a high frequency power. Please take notice that do not leakage the unnecessary electric wave and use this products without cause damage for human and property per normal operation.

3.Before use; Before use the product,Please design the equipment in consideration of the risk for human and electric wave obstacle for equipment.

PRECAUTIONS FOR THE USE OF MITSUBISHI SILICON RF POWER DEVICES:

1. The specifications of mention are not guarantee values in this data sheet. Please confirm additional details regarding operation of these products from the formal specification sheet. For copies of the formal specification sheets, please contact one of our sales offices.

2.RA series products (RF power amplifier modules) and RD series products (RF power transistors) are designed for consumer mobile communication terminals and were not specifically designed for use in other applications. In particular, while these products are highly reliable for their designed purpose, they are not manufactured under a quality assurance testing protocol that is sufficient to guarantee the level of reliability typically deemed necessary for critical communications elements and In the application, which is base station applications and fixed station applications that operate with long term continuous transmission and a higher on-off frequency during transmitting, please consider the derating, the redundancy system, appropriate setting of the maintain period and others as needed. For the reliability report which is described about predicted operating life time of Mitsubishi Silicon RF Products , please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor.

3. RD series products use MOSFET semiconductor technology. They are sensitive to ESD voltage therefore appropriate ESD precautions are required.

4. In the case of use in below than recommended frequency, there is possibility to occur that the device is deteriorated or destroyed due to the RF-swing exceed the breakdown voltage.

5. In order to maximize reliability of the equipment, it is better to keep the devices temperature low. It is recommended to utilize a sufficient sized heat-sink in conjunction with other cooling methods as needed (fan, etc.) to keep the channel temperature for RD series products lower than 120deg/C(in case of Tchmax=150deg/C) ,140deg/C(in case of Tchmax=175deg/C) under standard conditions.

6. Do not use the device at the exceeded the maximum rating condition. In case of plastic molded devices, the exceeded maximum rating condition may cause blowout, smoldering or catch fire of the molding resin due to extreme short current flow between the drain and the source of the device. These results causes in fire or injury.

7. For specific precautions regarding assembly of these products into the equipment, please refer to the supplementary items in the specification sheet.

8. Warranty for the product is void if the products protective cap (lid) is removed or if the product is modified in any way from it's original form.

9. For additional "Safety first" in your circuit design and notes regarding the materials, please refer the last page of this data sheet.

10. Please refer to the additional precautions in the formal specification sheet.

Keep safety first in your circuit designs!

Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials

- These materials are intended as a reference to assist our customers in the selection of the Mitsubishi semiconductor product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Mitsubishi Electric Corporation or a third party.
- Mitsubishi Electric Corporation assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials.
- All information contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Mitsubishi Electric Corporation without notice due to product improvements or other reasons. It is therefore recommended that customers contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor for the latest product information before purchasing a product listed herein.
  The information described here may contain technical inaccuracies or typographical errors. Mitsubishi Electric Corporation assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.
  Please also pay attention to information published by Mitsubishi Electric Corporation by various means, including the Mitsubishi Semiconductor home page (http://www.MitsubishiElectric.com/).
- When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Mitsubishi Electric Corporation assumes no responsibility for any damage, liability or other loss resulting from the information contained herein.
- Mitsubishi Electric Corporation semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
- The prior written approval of Mitsubishi Electric Corporation is necessary to reprint or reproduce in whole or in part these materials.
- If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.
  Any diversion or re-export contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.
- Please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor for further details on these materials or the products contained therein.

© 2011 MITSUBISHI ELECTRIC CORPORATION. ALL RIGHTS RESERVED.
Publication Date : Oct. 2011

OCEAN CHIPS
Океан Электроники
Поставка электронных компонентов

Компания «Океан Электроники» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «**JONHON**», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «**FORSTAR**».

AVIC JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).

FORSTAR®

Телефон: 8 (812) 309-75-97 (многоканальный)
Факс: 8 (812) 320-03-32
Электронная почта: ocean@oceanchips.ru
Web: http://oceanchips.ru/
Адрес: 198099, г. Санкт-Петербург, ул. Калинина, д. 2, корп. 4, лит. А